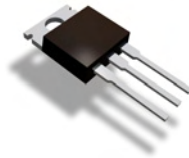


Features

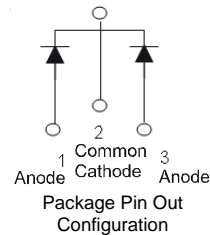
- Ultra Low Forward Voltage Drop
- Excellent High Temperature Stability
- Patented Super Barrier Rectifier Technology
- Soft, Fast Switching Capability
- 150°C Operating Junction Temperature
- **Lead Free Finish, RoHS Compliant (Note 2)**



Top View

Mechanical Data

- Case: TO-220AB
- Case Material: Molded Plastic, UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Matte Tin Finish annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 (E3)
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 2.1 grams (approximate)



Maximum Ratings @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V_{RRM}	200	V
Working Peak Reverse Voltage	V_{RWM}		
DC Blocking Voltage	V_{RM}		
RMS Reverse Voltage	$V_{R(RMS)}$	141	V
Average Rectified Output Current @ $T_C = 150^\circ\text{C}$	I_O	40	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I_{FSM}	240	A

Thermal Characteristics

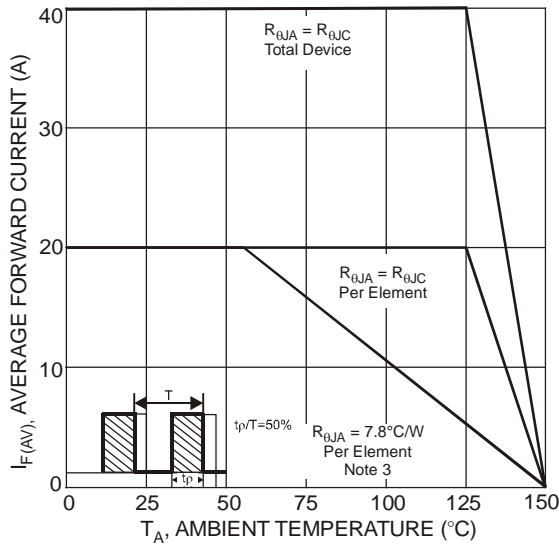
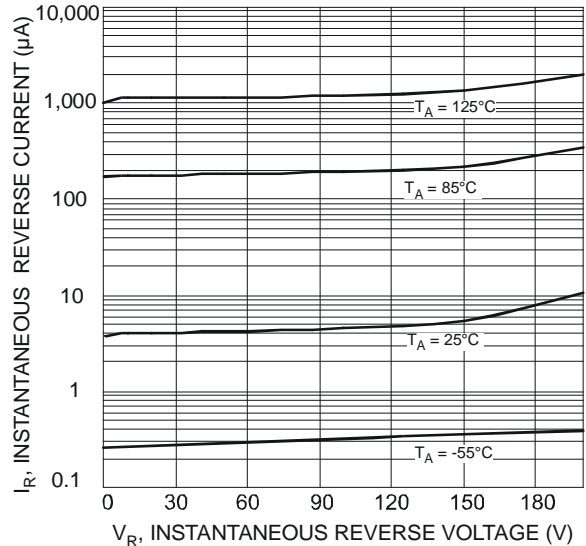
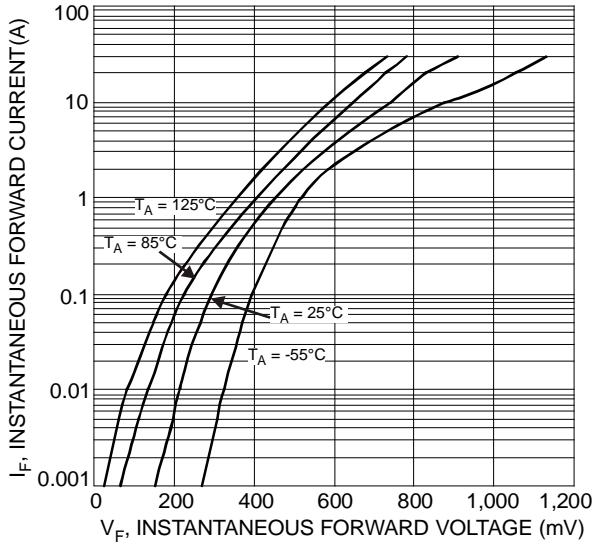
Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance (per leg)			
Thermal Resistance Junction to Case (Note 3)	$R_{\theta JC}$	0.6	$^\circ\text{C/W}$
Thermal Resistance, Junction to Ambient (Note 3)	$R_{\theta JA}$	7.8	
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to +150	$^\circ\text{C}$

Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 1)	$V_{(BR)R}$	200	-	-	V	$I_R = 200\mu\text{A}$
Forward Voltage Drop (per leg)	V_F	-	0.83 0.68	0.89 0.73	V	$I_F = 20\text{A}, T_J = 25^\circ\text{C}$ $I_F = 20\text{A}, T_J = 125^\circ\text{C}$
Leakage Current (Note 1)	I_R	-	-	0.2 40	mA	$V_R = 200\text{V}, T_J = 25^\circ\text{C}$ $V_R = 200\text{V}, T_J = 125^\circ\text{C}$
Reverse Recovery Time	t_{rr}	-	38 25	50 35	ns	$I_F = 0.5\text{A}, I_R = 1\text{A}, I_{RR} = 0.25\text{A}$ $I_F = 1\text{A}, V_R = 30\text{V}$ $di/dt = 100\text{A}/\mu\text{s}, T_J = 25^\circ\text{C}$

- Notes:
1. Short duration pulse test used to minimize self-heating effect.
 2. RoHS revision 13.2.2003. High temperature solder exemption applied, see *EU Directive Annex Note 7*.
 3. Device mounted on heatsink (Black Aluminum, 50mm x 37mm x 15mm)

SBR is a registered trademark of Diodes Incorporated.

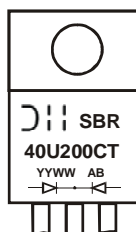


Ordering Information (Note 4)

Part Number	Case	Packaging
SBR40U200CT	TO-220AB	50 pieces/tube

Notes: 4. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

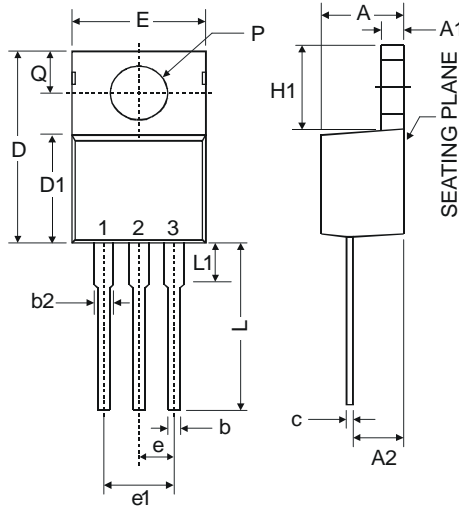
Marking Information



SBR40U200CT = Product Type Marking Code
 AB = Foundry and Assembly Code
 YYWW = Date Code Marking
 YY = Last two digits of year, ex: 07 = 2007
 WW = Week (01-52)

SBR is a registered trademark of Diodes Incorporated.

Package Outline Dimensions



TO-220AB			
Dim	Min	Typ	Max
A	3.56	-	4.82
A1	0.51	-	1.39
A2	2.04	-	2.92
b	0.39	0.81	1.01
c	0.356	-	0.61
D	14.22	-	16.51
D1	8.39	-	9.01
e	2.54		
e1	5.08		
E	9.66	-	10.66
H1	5.85	-	6.85
L	12.70	-	14.73
L1	-	-	6.35
P	3.54	-	4.08
Q	2.54	-	3.42
All Dimensions in mm			

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